

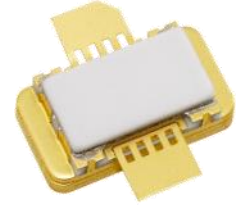
■ Features

- High Voltage Operation : $V_{DS}=50V$
- High Power : 50.8dBm (typ.) @ P_{sat}
- Proven Reliability

■ Description

Sumitomo Electric's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use from 0.7GHz to 2.7GHz W-CDMA and LTE design requirements as it offers high gain, long term reliability and ease of use.



ABSOLUTE MAXIMUM RATINGS (Case Temperature $T_c=25\text{deg.C}$)

Item	Symbol	Condition	Rating	Unit
Operating Voltage	V_{DS}		55	V
Drain-Source Voltage	V_{DS}	$V_{GS} = -8V$	160	V
Gate-Source Voltage	V_{GS}		-15	V
Total Power Dissipation	P_t		112.5	W
Storage Temperature	T_{stg}		-65 to +175	deg.C
Channel Temperature	T_{ch}		250	deg.C

RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	V_{DS}		≤ 55	V
Forward Gate Current	I_{GF}	$R_G = 5 \text{ ohm}$	≤ 95	mA
Reverse Gate Current	I_{GR}	$R_G = 5 \text{ ohm}$	≥ -3.5	mA
Channel Temperature	T_{ch}		≤ 200	deg.C
Average Output Power	$P_{ave.}$		≤ 47.8	dBm

ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25\text{deg.C}$)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	V_p	$V_{DS}=50V$ $I_{DS}=24mA$	-4.0	-	-2.0	V
Saturated Power	$P_{sat} *1$	$V_{DS}=50V$	49.8	50.8	-	dBm
Drain Efficiency at P_{sat}	$DE *1$	$I_{DS(DC)}=0mA$ $f=2.65GHz$	53.0	60.0	-	%
Power Gain	$G_p *2$	$I_{DS(DC)}=400mA$	16.0	17.0	-	dB
Thermal Resistance	R_{th}	Channel to Case at 52.5W P_{DC}	-	1.7	2.0	deg.C/W

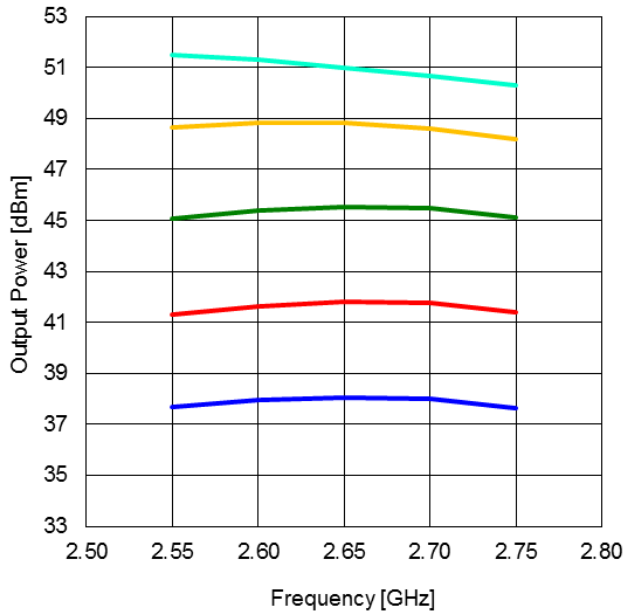
*1 : 10%-duty RF pulse (DC supply constant), Fixed $P_{in}=37dBm$

*2 : $P_{out}=43dBm$, CW modulation Signal (W-CDMA) $f=2.65GHz$

RoHS Compliance	YES
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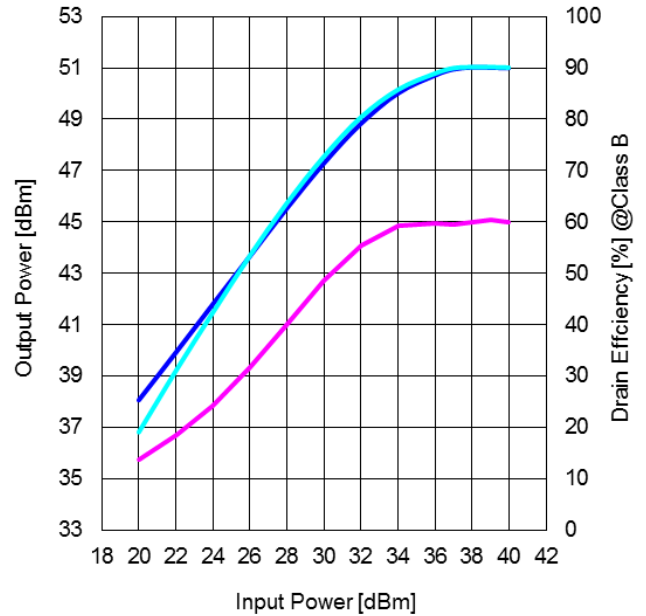
RF characteristics @f=2.65GHz fine tuned

Output Power vs. Frequency



Pin=20dBm Pin=24dBm Pin=28dBm
Pin=32dBm Pin=39dBm

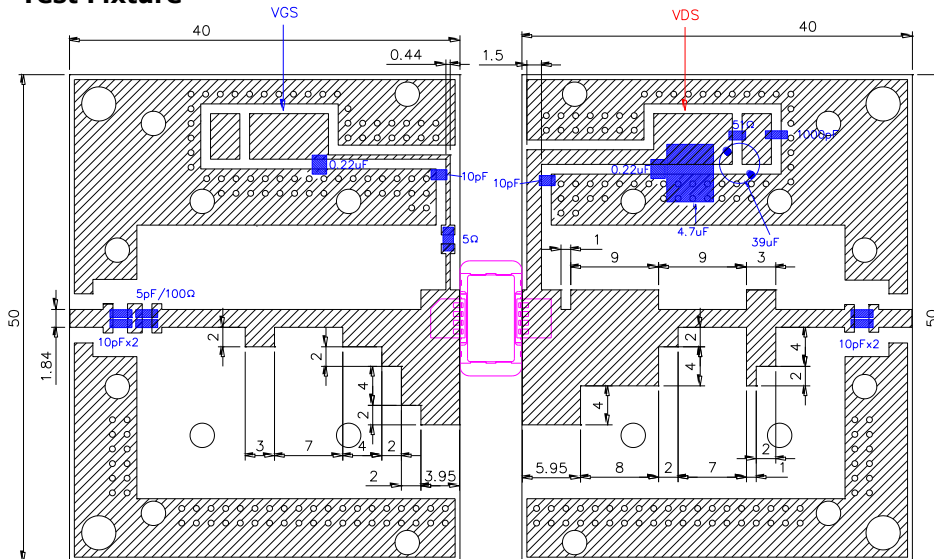
Output Power and Drain Efficiency vs. Input Power

$$V_{DS}=50V, I_{DS(DC)}=600mA, f=2.65GHz$$


— Pout (class AB) — Pout (Class B) — DE (class B)

Pulse Signal (10%-duty, DC : constant)

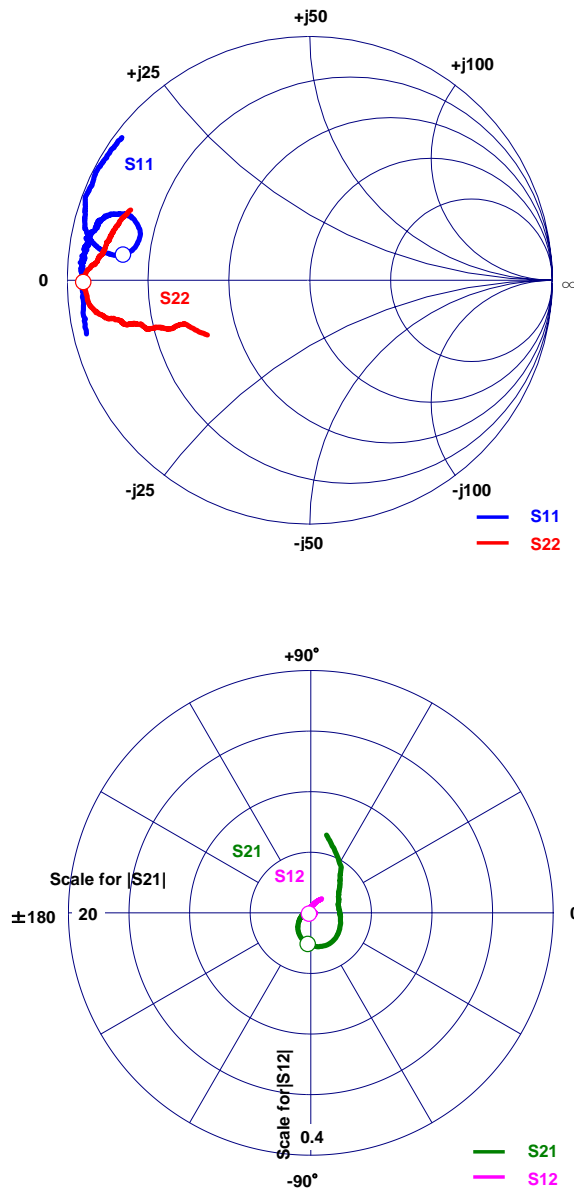
Test Fixture



h=0.8mm $\epsilon_r=3.5$
Cu=18um Unit: mm

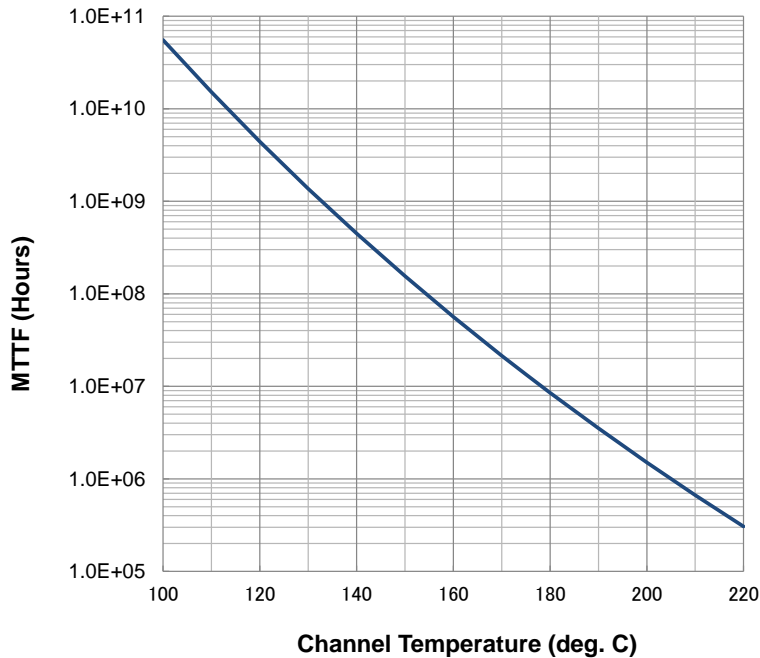
- Reference DATA -

S-Parameters @VDS=50V, IDS(DC)=600mA, f=0.5 to 4.5GHz
ZI = Zs = 50ohm Marker : 2.65GHz



Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.50	0.95	-166.52	6.56	78.51	0.01	10.83	0.48	-151.99
0.60	0.94	-174.17	5.38	67.46	0.01	7.03	0.51	-156.19
0.70	0.94	178.20	4.53	56.32	0.01	0.15	0.54	-160.41
0.80	0.95	177.14	3.95	52.07	0.01	-1.08	0.57	-161.17
0.90	0.94	175.35	3.55	47.44	0.01	3.16	0.58	-160.97
1.00	0.94	174.16	3.27	42.47	0.01	0.01	0.61	-160.89
1.10	0.94	172.80	2.97	37.94	0.01	0.42	0.63	-161.64
1.20	0.94	171.24	2.76	33.83	0.01	3.77	0.65	-162.76
1.30	0.93	170.56	2.64	29.41	0.01	1.62	0.67	-162.83
1.40	0.93	169.28	2.55	24.80	0.01	3.26	0.69	-163.05
1.50	0.92	168.32	2.43	20.22	0.01	3.95	0.70	-164.12
1.60	0.91	167.12	2.37	15.55	0.01	5.19	0.72	-165.34
1.70	0.91	165.34	2.34	9.59	0.01	2.66	0.74	-165.88
1.80	0.90	164.43	2.38	3.97	0.01	-0.95	0.76	-166.16
1.90	0.88	163.16	2.41	-2.10	0.01	-2.87	0.78	-166.63
2.00	0.87	162.21	2.48	-8.18	0.01	-6.36	0.80	-167.38
2.10	0.84	161.27	2.58	-17.42	0.01	-12.13	0.81	-168.47
2.20	0.80	160.19	2.68	-27.21	0.01	-23.33	0.85	-169.13
2.30	0.78	160.78	2.83	-38.48	0.01	-39.45	0.87	-170.78
2.40	0.74	163.00	2.96	-52.46	0.01	-56.10	0.90	-172.54
2.50	0.72	166.97	2.93	-69.38	0.01	-86.27	0.92	-174.88
2.60	0.75	170.99	2.72	-87.58	0.00	-123.80	0.93	-178.29
2.70	0.81	172.66	2.40	-103.75	0.00	-176.32	0.93	179.18
2.80	0.86	172.15	2.03	-117.72	0.01	144.69	0.91	176.93
2.90	0.90	170.70	1.67	-129.96	0.01	124.16	0.89	175.91
3.00	0.93	168.87	1.38	-138.86	0.01	110.01	0.88	174.97
3.10	0.95	166.87	1.15	-146.20	0.01	101.02	0.88	173.86
3.20	0.96	164.87	0.97	-153.39	0.01	93.59	0.87	173.01
3.30	0.97	163.11	0.83	-158.99	0.01	88.05	0.86	172.32
3.40	0.98	161.52	0.71	-164.30	0.01	82.82	0.86	171.77
3.50	0.99	159.99	0.63	-168.75	0.01	79.27	0.85	170.66
3.60	0.98	158.18	0.56	-172.47	0.01	76.44	0.85	169.56
3.70	0.98	156.74	0.50	-177.16	0.01	74.25	0.84	168.80
3.80	0.98	154.96	0.45	-178.86	0.02	70.28	0.84	167.72
3.90	0.99	153.30	0.41	-174.73	0.02	68.66	0.84	166.60
4.00	0.98	151.68	0.38	-170.61	0.02	66.09	0.83	165.40
4.10	0.98	150.40	0.35	-167.07	0.02	63.71	0.82	164.28
4.20	0.98	148.59	0.33	-162.89	0.02	61.77	0.82	163.36
4.30	0.98	146.46	0.31	-158.29	0.02	58.15	0.81	161.64
4.40	0.97	144.81	0.29	-154.02	0.03	54.91	0.80	160.33
4.50	0.97	142.94	0.28	-149.74	0.03	52.17	0.79	158.66

MTTF Calculation – Estimated MTTF –



Ea=1.6eV
Confidence Level=90%

Channel Temp (deg.C)	MTTF (Hours)
160	5.98 x 10 ⁷
180	9.02 x 10 ⁶
200	1.60 x 10 ⁶

$$AF = \exp\left[\frac{-E_a}{k}\left(\frac{1}{T_{\text{stress}}} - \frac{1}{T_{\text{use}}}\right)\right]$$

$$MTTF_{\text{use}} = MTTF_{\text{stress}} * AF$$

Where;

AF: acceleration factor

Ea: activation energy (1.6 eV)

k: Boltzman's constant (8.62 x 10⁻⁵ eV/K)

T_{stress}: stress temperature (K)

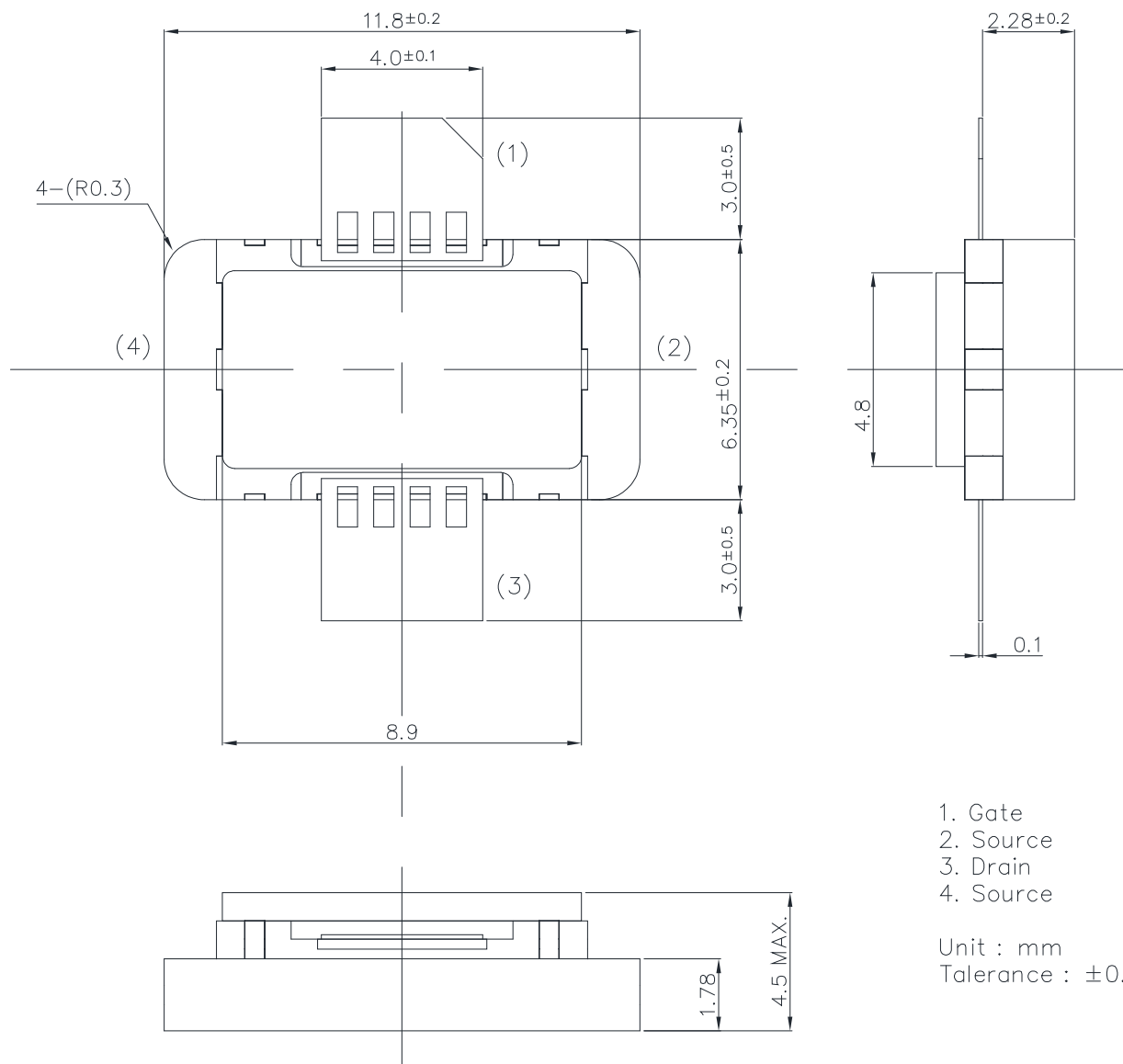
T_{use}: use temperature (K)

ESD characteristic

Test Methodology	Class
Human Body Model (per JESD22-A114)	1A
Machine Model (per JEIA/ESD22-A115)	A
Device Charged Model (per JESD22-C101)	IV



**M1H Package Outline
Metal-Ceramic Hermetic Package**



- 1. Gate
- 2. Source
- 3. Drain
- 4. Source

Unit : mm
Tolerance : ± 0.15

For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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